Inverter with open-drain output Rev. 7 — 18 November 2014

#### **General description** 1.

74AHC1G06 and 74AHCT1G06 are high-speed Si-gate CMOS devices. They provide an inverting buffer. The output of these devices is an open-drain and can be connected to other open-drain outputs to implement active-LOW, wired-OR or active-HIGH, wired-AND functions. For digital operation this device must have a pull-up resistor to establish a logic HIGH-level.

The AHC device has CMOS input switching levels and supply voltage range 2 V to 5.5 V.

The AHCT device has TTL input switching levels and supply voltage range 4.5 V to 5.5 V.

#### 2. **Features and benefits**

- High noise immunity
- Low power dissipation
- SOT353-1 and SOT753 package options
- ESD protection:
  - HBM JESD22-A114E: exceeds 2000 V
  - MM JESD22-A115-A: exceeds 200 V
  - CDM JESD22-C101C: exceeds 1000 V
- Specified from -40 °C to +125 °C

#### 3. Ordering information

#### Table 1. **Ordering information**

Type number	Package			
	Temperature range	Name	Description	Version
74AHC1G06GW	–40 °C to +125 °C	TSSOP5	plastic thin shrink small outline package;	SOT353-1
74AHCT1G06GW			5 leads; body width 1.25 mm	
74AHC1G06GV	–40 °C to +125 °C	SC-74A	plastic surface-mounted package; 5 leads	SOT753
74AHCT1G06GV				



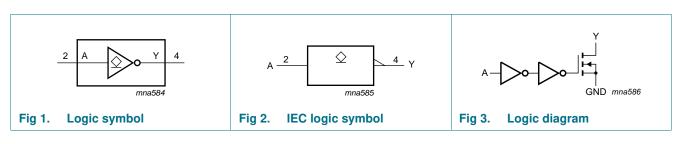
Inverter with open-drain output

### 4. Marking

Table 2. Marking codes					
Type number	Marking <sup>[1]</sup>				
74AHC1G06GW	AR				
74AHC1G06GV	A06				
74AHCT1G06GW	CR				
74AHCT1G06GV	C06				

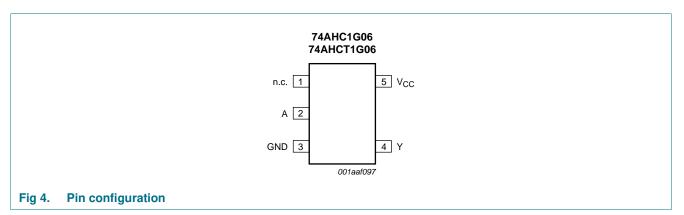
[1] The pin 1 indicator is located on the lower left corner of the device, below the marking code.

## 5. Functional diagram



## 6. Pinning information

### 6.1 Pinning



### 6.2 Pin description

Table 3. Pi	Fable 3.         Pin description						
Symbol	Pin	Description					
n.c.	1	not connected					
A	2	data input					
GND	3	ground (0 V)					
Y	4	data output					
V <sub>CC</sub>	5	supply voltage					

## 7. Functional description

#### Table 4. Function table

H = HIGH voltage level; L = LOW voltage level; Z = high-impedance OFF-state

Input	Output
Α	Y
L	Z
Н	L

## 8. Limiting values

#### Table 5.Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V <sub>CC</sub>	supply voltage			-0.5	+7.0	V
VI	input voltage			-0.5	+7.0	V
I <sub>IK</sub>	input clamping current	V <sub>1</sub> < -0.5 V		-20	-	mA
I <sub>OK</sub>	output clamping current	V <sub>O</sub> < -0.5 V	<u>[1]</u>	-	±20	mA
lo	output current	$V_{\rm O} > -0.5 \ {\rm V}$		-	±25	mA
Vo	output voltage	active mode	[1]	-0.5	+7.0	V
		high-impedance mode	[1]	-0.5	+7.0	V
I <sub>CC</sub>	supply current			-	75	mA
I <sub>GND</sub>	ground current			-75	-	mA
T <sub>stg</sub>	storage temperature			-65	+150	°C
P <sub>tot</sub>	total power dissipation	$T_{amb} = -40 \text{ °C to } +125 \text{ °C}$	[2]	-	250	mW

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] For both TSSOP5 and SC-74A packages: above 87.5 °C the value of Ptot derates linearly with 4.0 mW/K.

## 9. Recommended operating conditions

#### Table 6. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	74	74AHC1G06			74AHCT1G06		
			Min	Тур	Max	Min	Тур	Max	
V <sub>CC</sub>	supply voltage		2.0	5.0	5.5	4.5	5.0	5.5	V
VI	input voltage		0	-	5.5	0	-	5.5	V
Vo	output voltage	active mode	0	-	V <sub>CC</sub>	0	-	V <sub>CC</sub>	V
		high-impedance mode	0	-	6.0	0	-	6.0	V
T <sub>amb</sub>	ambient temperature		-40	+25	+125	-40	+25	+125	°C
Δt/ΔV	input transition rise	$V_{CC}=3.3~V\pm0.3~V$	-	-	100	-	-	-	ns/V
	and fall rate	$V_{CC}=5.0~V\pm0.5~V$	-	-	20	-	-	20	ns/V

Inverter with open-drain output

## **10. Static characteristics**

#### Table 7.Static characteristics

Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	25 °C			–40 °C to +85 °C		–40 °C to +125 °C		Unit
			Min	Тур	Max	Min	Max	Min	Max	
For type	74AHC1G06				1		1	1	1	-1
VIH HIGH-level		V <sub>CC</sub> = 2.0 V	1.5	-	-	1.5	-	1.5	-	V
	input voltage	V <sub>CC</sub> = 3.0 V	2.1	-	-	2.1	-	2.1	-	V
		V <sub>CC</sub> = 5.5 V	3.85	-	-	3.85	-	3.85	-	V
V <sub>IL</sub>	LOW-level	V <sub>CC</sub> = 2.0 V	-	-	0.5	-	0.5	-	0.5	V
	input voltage	V <sub>CC</sub> = 3.0 V	-	-	0.9	-	0.9	-	0.9	V
		V <sub>CC</sub> = 5.5 V	-	-	1.65	-	1.65	-	1.65	V
V <sub>OL</sub>	LOW-level	$V_{I} = V_{IH} \text{ or } V_{IL}$								
	output voltage	$I_{O} = 50 \ \mu A; V_{CC} = 2.0 \ V$	-	0	0.1	-	0.1	-	0.1	V
		$I_{O} = 50 \ \mu A; V_{CC} = 3.0 \ V$	-	0	0.1	-	0.1	-	0.1	V
		$I_{O} = 50 \ \mu A; V_{CC} = 4.5 \ V$	-	0	0.1	-	0.1	-	0.1	V
		$I_{O} = 4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.36	-	0.44	-	0.55	V
		$I_{O} = 8.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	-	-	0.36	-	0.44	-	0.55	V
lı	input leakage current	V <sub>I</sub> = 5.5 V or GND; V <sub>CC</sub> = 0 V to 5.5 V	-	-	0.1	-	1.0	-	2.0	μA
I <sub>OZ</sub>	OFF-state output current	$V_{I} = V_{IH} \text{ or } V_{IL}; V_{O} = V_{CC} \text{ or}$ GND; $V_{CC} = 5.5 \text{ V}$	-	-	±0.25		±2.5		±10.0	μA
I <sub>CC</sub>	supply current	$\label{eq:VI} \begin{array}{l} V_{I} = V_{CC} \text{ or } GND; \ I_{O} = 0 \ A; \\ V_{CC} = 5.5 \ V \end{array}$	-	-	1.0	-	10	-	20	μA
CI	input capacitance		-	1.5	10	-	10	-	10	pF
For type	74AHCT1G06									
V <sub>IH</sub>	HIGH-level input voltage	$V_{CC}$ = 4.5 V to 5.5 V	2.0	-	-	2.0	-	2.0	-	V
V <sub>IL</sub>	LOW-level	$V_{CC}$ = 4.5 V to 5.5 V	-	-	0.8	-	0.8	-	0.8	V
V <sub>OL</sub>	LOW-level	$V_{I} = V_{IH}$ or $V_{IL}$ ; $V_{CC} = 4.5$ V								
	output voltage	$I_{O} = 50 \ \mu A$	-	0	0.1	-	0.1	-	0.1	V
		$I_0 = 8.0 \text{ mA}$	-	-	0.36	-	0.44	-	0.55	V
I	input leakage current	V <sub>I</sub> = 5.5 V or GND; V <sub>CC</sub> = 0 V to 5.5 V	-	-	0.1	-	1.0	-	2.0	μA
I <sub>OZ</sub>	OFF-state output current	$V_{I} = V_{IH} \text{ or } V_{IL}; V_{O} = V_{CC} \text{ or}$ GND; $V_{CC} = 5.5 \text{ V}$	-	-	±0.25		±2.5		±10.0	μA
I <sub>CC</sub>	supply current		-	-	1.0	-	10	-	20	μA
Δl <sub>CC</sub>	additional supply current	per input pin; $V_1 = 3.4 V$ ; other inputs at $V_{CC}$ or GND; $I_O = 0 A$ ; $V_{CC} = 5.5 V$	-	-	1.35	-	1.5	-	1.5	mA
Cı	input capacitance		-	1.5	10	-	10	-	10	pF

Inverter with open-drain output

## **11. Dynamic characteristics**

#### Table 8.Dynamic characteristics

GND = 0 V;  $t_r = t_f = \le 3.0$  ns. For test circuit see <u>Figure 6</u>.

Symbol Parameter		r Conditions			25 °C		–40 °C	to +85 °C	–40 °C to +125 °C		Unit
				Min	Тур	Max	Min	Max	Min	Max	
For type	74AHC1G06	1									
t <sub>PZL</sub>	OFF-state	A to Y; see Figure 5									
	to LOW propagation	$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	[1]								
	delay	C <sub>L</sub> = 15 pF		-	3.7	7.0	1.0	7.7	1.0	8.1	ns
		C <sub>L</sub> = 50 pF		-	5.2	10.0	1.0	11.0	1.0	11.5	ns
		$V_{CC} = 4.5 \text{ V} \text{ to } 5.5 \text{ V}$	[2]								
		C <sub>L</sub> = 15 pF		-	2.7	4.9	1.0	5.3	1.0	5.6	ns
		C <sub>L</sub> = 50 pF		-	3.8	7.0	1.0	7.5	1.0	8.0	ns
t <sub>PLZ</sub>	LOW to	A to Y; see Figure 5									
	OFF-state	$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	[1]								
	propagation delay	C <sub>L</sub> = 15 pF		-	4.8	6.4	1.0	6.9	1.0	7.4	ns
	,	C <sub>L</sub> = 50 pF		-	6.9	10.0	1.0	10.5	1.0	11.0	ns
		$V_{CC} = 4.5 \text{ V} \text{ to } 5.5 \text{ V}$	[2]								
		C <sub>L</sub> = 15 pF		-	3.0	4.1	1.0	4.6	1.0	5.1	ns
		C <sub>L</sub> = 50 pF		-	4.3	6.5	1.0	7.0	1.0	7.5	ns
C <sub>PD</sub>	power dissipation capacitance	per buffer; $C_L = 50 \text{ pF}; \text{ f} = 1 \text{ MHz};$ $V_I = \text{GND to } V_{CC}$	<u>[3]</u>	-	3	-	-	-	-	-	pF
For type	74AHCT1G06										
t <sub>PZL</sub>	OFF-state	A to Y; see Figure 5									
	to LOW propagation	$V_{CC} = 4.5 \text{ V} \text{ to } 5.5 \text{ V}$	[2]								
	delay	C <sub>L</sub> = 15 pF		-	3.0	5.3	1.0	6.0	1.0	6.3	ns
		C <sub>L</sub> = 50 pF		-	4.2	7.5	1.0	8.5	1.0	9.0	ns
t <sub>PLZ</sub>	LOW to	A to Y; see Figure 5									
	OFF-state propagation	$V_{CC} = 4.5 \text{ V} \text{ to } 5.5 \text{ V}$	[2]								
	delay	C <sub>L</sub> = 15 pF		-	3.2	4.6	1.0	5.1	1.0	5.6	ns
		C <sub>L</sub> = 50 pF		-	4.5	7.0	1.0	7.5	1.0	8.0	ns
C <sub>PD</sub>	power dissipation capacitance	per buffer; $C_L = 50 \text{ pF}; f = 1 \text{ MHz};$ $V_I = \text{GND} \text{ to } V_{CC}$	<u>[3]</u>	-	4.5	-	-	-	-	-	pF

[1] Typical values are measured at  $V_{CC}$  = 3.3 V.

[2] Typical values are measured at  $V_{CC}$  = 5.0 V.

[3]  $C_{PD}$  is used to determine the dynamic power dissipation  $P_D$  ( $\mu W$ ).

 $P_D = C_{PD} \times V_{CC}^2 \times f_i + \sum (C_L \times V_{CC}^2 \times f_o)$  where:

 $f_i = input frequency in MHz;$ 

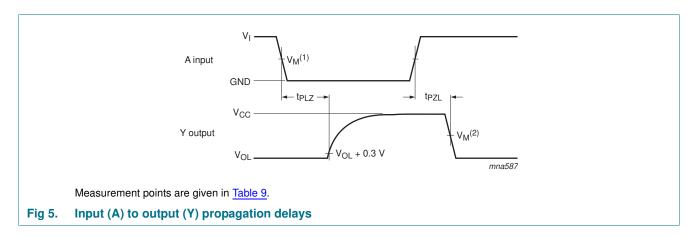
 $f_o = output frequency in MHz;$ 

 $C_L$  = output load capacitance in pF;

V<sub>CC</sub> = supply voltage in Volts

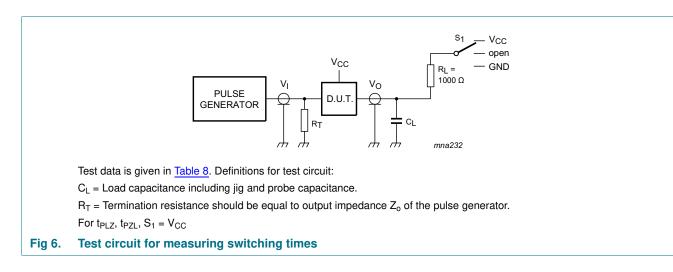
Inverter with open-drain output

### 12. Waveforms



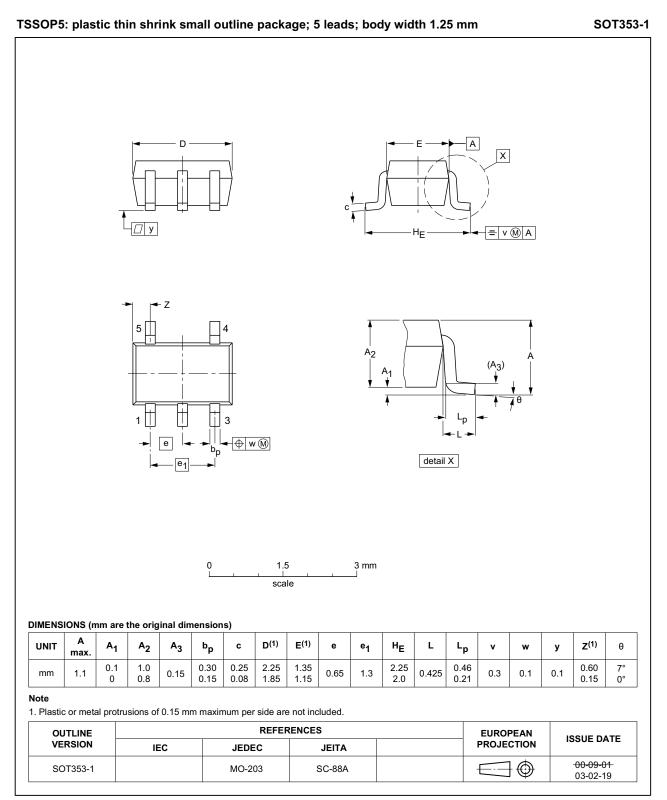
#### Table 9.Measurement point

Туре	Input	Output	
	VI	V <sub>M</sub> <sup>(1)</sup>	V <sub>M</sub> <sup>(2)</sup>
74AHC1G06	GND to V <sub>CC</sub>	$0.5  imes V_{CC}$	$0.5  imes V_{CC}$
74AHCT1G06	GND to 3.0 V	1.5 V	$0.5  imes V_{CC}$



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## 13. Package outline

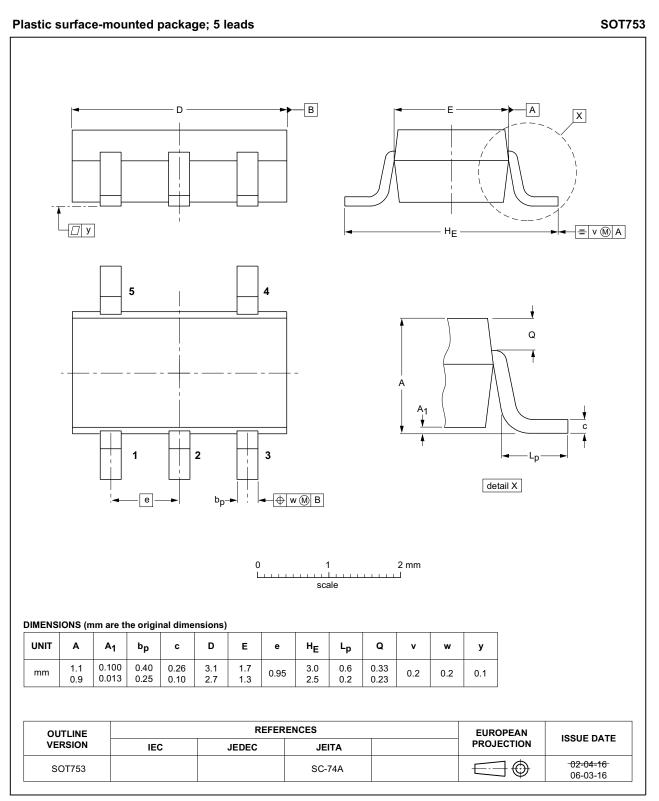


#### Fig 7. Package outline SOT353-1 (TSSOP5)

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#### Fig 8. Package outline SOT753 (SC-74A)

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## 14. Abbreviations

Table 10. Abbrevi	Table 10. Abbreviations					
Acronym	Description					
CDM	Charged Device Model					
DUT	Device Under Test					
ESD	ElectroStatic Discharge					
HBM	Human Body Model					
MM	Machine Model					
TTL	Transistor-Transistor Logic					

## 15. Revision history

#### Table 11. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74AHC_AHCT1G06 v.7	20141118	Product data sheet	-	74AHC_AHCT1G06 v.6
Modifications:	<u>Section 4</u> : tab	ole note added.	·	
74AHC_AHCT1G06 v.6	20070607	Product data sheet	-	74AHC_AHCT1G06 v.5
Modifications:		f this data sheet has been rede NXP Semiconductors.	signed to comply w	ith the new identity
	<ul> <li>Legal texts have</li> </ul>	ave been adapted to the new c	ompany name whe	re appropriate.
	Package SO <sup>*</sup>	T353 changed to SOT353-1 in	Section 3 and Sect	<u>ion 13</u> .
	Quick referent	nce data and Soldering sections	s removed.	
74AHC_AHCT1G06 v.5	20021002	Product specification	-	74AHC_AHCT1G06 v.4
74AHC_AHCT1G06 v.4	20020528	Product specification	-	74AHC_AHCT1G06 v.3
74AHC_AHCT1G06 v.3	20020221	Product specification	-	74AHC_AHCT1G06 v.2
74AHC_AHCT1G06 v.2	20010209	Product specification	-	74AHC_AHCT1G06 v.1
74AHC_AHCT1G06 v.1	20000501	Product specification	-	-

Inverter with open-drain output

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Document status[1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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74AHC AHCT1G06

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Inverter with open-drain output

### **18. Contents**

1	General description 1
2	Features and benefits 1
3	Ordering information 1
4	Marking 2
5	Functional diagram 2
6	Pinning information 2
6.1	Pinning 2
6.2	Pin description 2
7	Functional description 3
8	Limiting values 3
9	Recommended operating conditions 3
10	Static characteristics 4
11	Dynamic characteristics 5
12	Waveforms 6
13	Package outline 7
14	Abbreviations9
15	Revision history
16	Legal information 10
16.1	Data sheet status 10
16.2	Definitions 10
16.3	Disclaimers 10
16.4	Trademarks 11
17	Contact information 11
18	Contents 12

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